

**SEMICONDUCTOR PACKAGE AND METHOD FOR MANUFACTURING THE
SAME**

Appl. No. : 10/710,399 Confirmation No. 4398
Applicant : Min-Jer Lin
Filed : July 8, 2004
TC/A.U. : 2818
Examiner : DAO H. NGUYEN
Docket No. : LKSP0027USA
Customer No. : 27765

Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

AMENDMENT

5 Sir:

In response to the Office action of December 14, 2006, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

10 **Amendments to the Claims** are reflected in the listing of claims which begins on page 4 of this paper.

Remarks/Arguments begin on page 9 of this paper.